

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Ligang Zhang et al.

Title: REDISTRIBUTION LAYER SHIELDING OF A CIRCUIT ELEMENT

Application No.: 10/814,816

Filed:

March 31, 2004

Examiner: Douglas W. Owens

Group Art Unit:

2821

Atty. Docket No.: 026-0041

Confirmation No.:

5295

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June 18, 2007

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**RESPONSE TO NON-FINAL OFFICE ACTION**

This paper is responsive to the Non-Final Office Action mailed on March 21, 2007, having a shortened statutory period for response set to expire June 21, 2007. In light of the Amendments and/or Remarks herein, further examination is requested.

Any fees required by this paper are being provided as directed in an electronic submission of this paper or in a transmittal letter accompanying this paper. However, the Commissioner is hereby authorized to charge any deficiency in fees required by this paper and any additional fees under 37 C.F.R. § 1.16 or 1.17 which may be required during the pendency of this application, and to similarly credit any overpayment, to Deposit Account 50-0631.